

PATENT ASSIGNMENT

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SUBMISSION TYPE:		NEW ASSIGNMENT
NATURE OF CONVEYANCE:		ASSIGNMENT
CONVEYING PARTY DATA		
Name		Execution Date
Intel Corporation		12/13/2007
RECEIVING PARTY DATA		
Name:	IMEC vzw	
Street Address:	Kapeldreef 75	
City:	Leuven	
State/Country:	BELGIUM	
Postal Code:	3001	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11484229	
CORRESPONDENCE DATA		
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NAME OF SUBMITTER:	Rose M. Thiessen	
Total Attachments: 2		
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Assignment

DATED: DEC 13, 2007 (Effective Date).

AMONG:

- (1) INTEL CORPORATION, a company incorporated in the State of Delaware, USA, having an address at 2200 Mission College Boulevard, Santa Clara, CA 95052, USA ("Intel")
- (2) "Inventor" as identified below

Name of Inventor	PAUL ZIMMERMAN
Citizenship	U.S.A.
Home address	141 Liano Court TX 78612 Cedar Creek

and

- (3) IMEC vzw, a non-profit organization established in Leuven (Belgium), having an address at Kapeldreef 75, 3001 Leuven, Belgium ("Assignee").

RECITALS:

Inventor, individually, as an employee of Intel, signed an employee agreement with Intel requiring an assignment to Intel of certain types of inventions ("Employment Agreement").

Intel participates in IMEC's Core Partner Research Program and as such entered into an agreement with IMEC, named Core Partner Agreement signed 8th September 2003, that provides for co-ownership of joint inventions.

Intel now wishes to release and assign any claim to the invention

"ATOMIC LAYER DEPOSITION METHOD FOR DEPOSITING A LAYER." (Invention)

that resulted under that Core Partner Agreement, which is filed as a US provisional application US 60/698,331 filed on July 11th, 2005 ; a US regular application US 11/484,229 filed on July 10th, 2006 ; a JP regular application JP 2006 190504 filed on July 11th, 2006 and an EP regular application EP 06116996.7 filed on July 11th, 2006 and to assign their respective rights, if any, to IMEC.

Now, therefore, Intel agrees as follows:

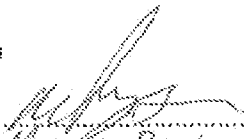
Intel certifies that the Inventor has assigned all title and interest that the Inventor may have had in the Invention to Intel via the Employment Agreement.

Assignment IMEC INTEL

Intel releases any claims to the Invention, and transfers and assigns, at Assignee's sole expense, to Assignee, all right, title and interest in and to the Invention and application and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letters Patent and Registrations which may hereafter be granted on the same in the United States and all countries throughout the world, and to claim the priority from the application as provided by the Paris Convention; (ii) the right to sue at law or in equity in respect of past, present and future infringement of any of such Inventions or patents issuing from the Inventions; and (iii) the right to receive all proceeds or damages from any such infringement.

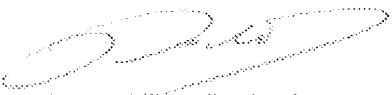
DULY EXECUTED:

Intel Corporation

Signed : 
Printed Name : Mitchell Reed
Title : General Services Director, Intel
Date : 12/13/07

LEGAL OK	
<i>Intel</i>	12/13/07

IMEC vzw

Signed : 
Printed Name : Professor Gilbert Declerck
Title : CEO
Date : 12/11/2008